

*Room temperature mechanical loss of high stress  
silicon nitride film measured by cantilever ring-down  
method on double-side coated cantilever*

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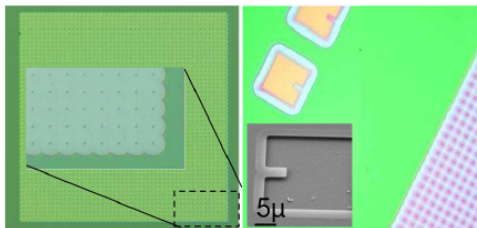
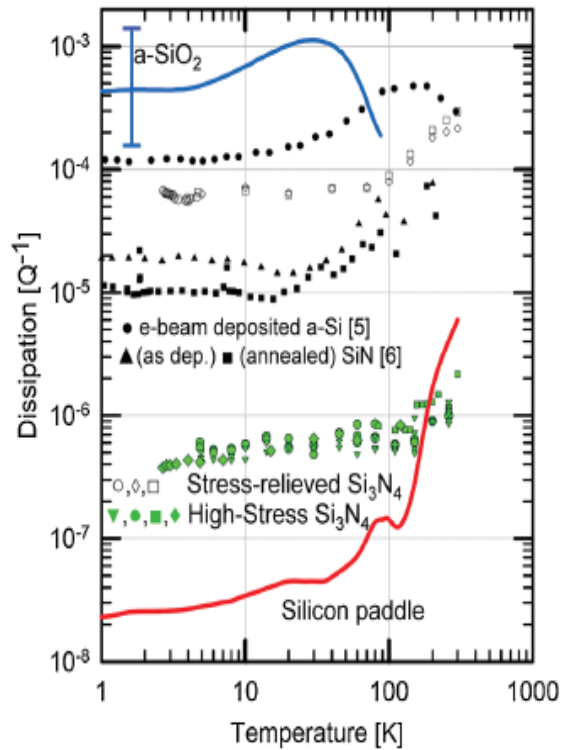
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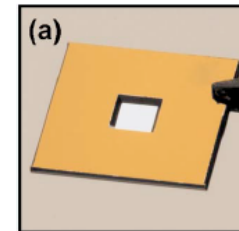
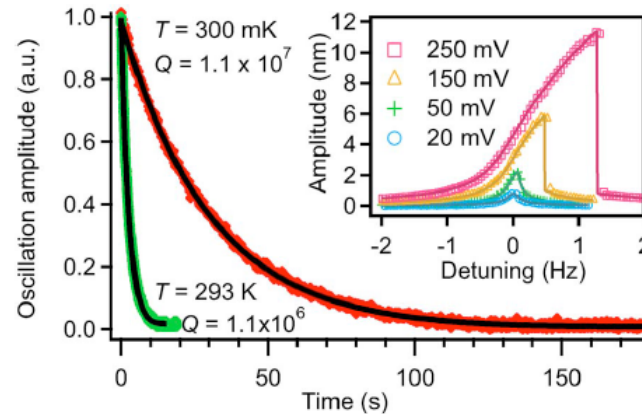
Hsinchu, Taiwan

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# Why silicon nitride



Ref. 1: D. R. Southworth, et al. PhysRevLett. **102**.225503(2009)



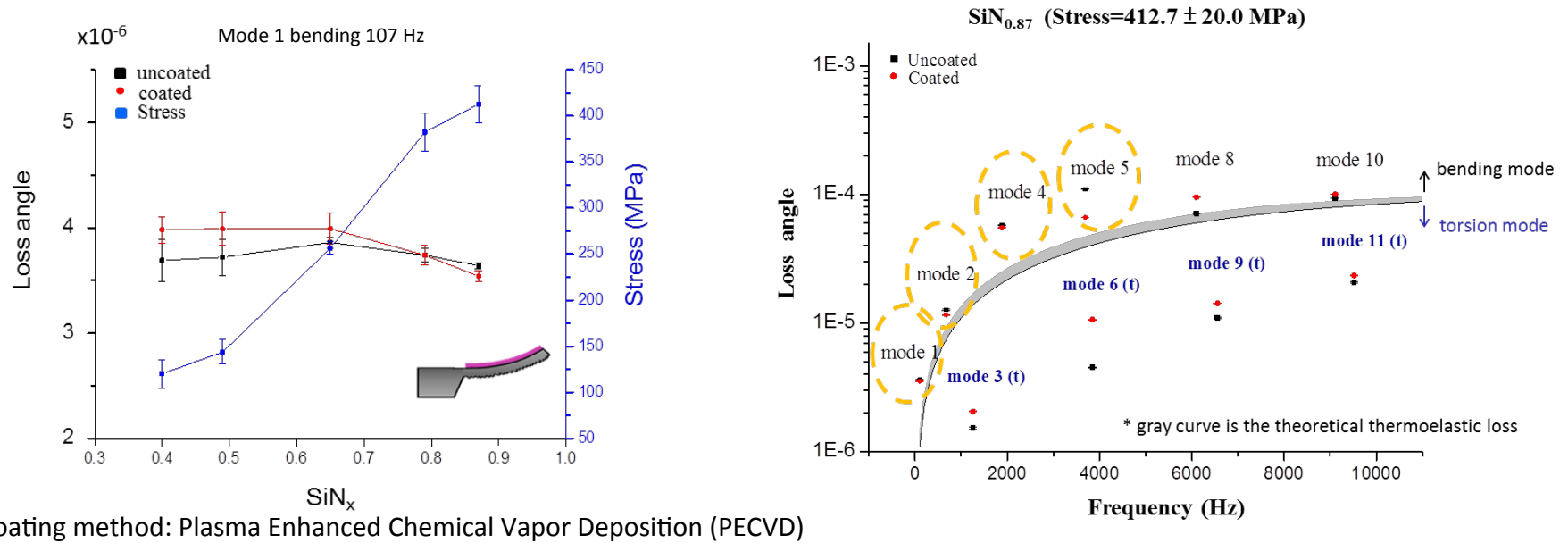
1 mm x 1 mm x 50 nm  
Norcada x-ray membrane.

Ref. 2: B. M. Zwickl, et al. Appl. D Phys. Lett. **92**, 103125 (2008)

Stressed SiN film has low loss, particularly at cryogenic temperature.

Our objective is to study this property in the frequency range of laser interference gravitational wave detector and explore the possibility of using CVD method for mirror deposition.

# What we had previously



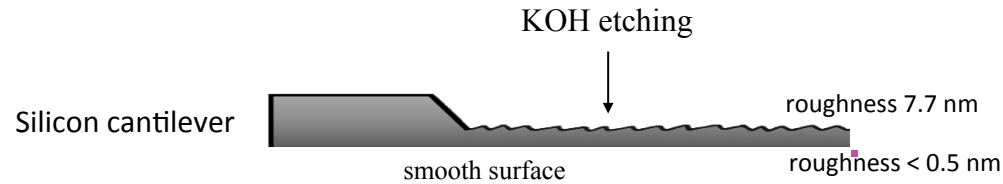
- The SiN<sub>x</sub> films were coated on silicon cantilever. Stress of the SiN<sub>x</sub> increased with  $x$ .
- The coated cantilevers were warped due to the tensile stress of the film.
- Loss angle of the high stress coated cantilever was lower than that of the uncoated, i.e. inversion, for most of the bending modes, **but none of the torsion modes showed inversion.**
- The measured resonant frequency of the coated cantilever differed from that of the uncoated by less than 0.1%, far less than the estimated frequency variation required for dissipation dilution, i.e. coefficient of dissipation dilution\* approximately equaled to 1. (\* : Phys. Rev. B 84, 174109, 2011)
- Since the torsion modes of the silicon cantilever are not susceptible to thermoelastics loss, therefore, we speculated that the inversion of the bending modes could be caused by reduction of the thermoelastics loss of the silicon cantilever under stress.

**How to obtain the loss angle of the inverted bending modes for the high stress SiN<sub>x</sub> film on Si cantilever?**



**double-side coating**

# Double-side coating

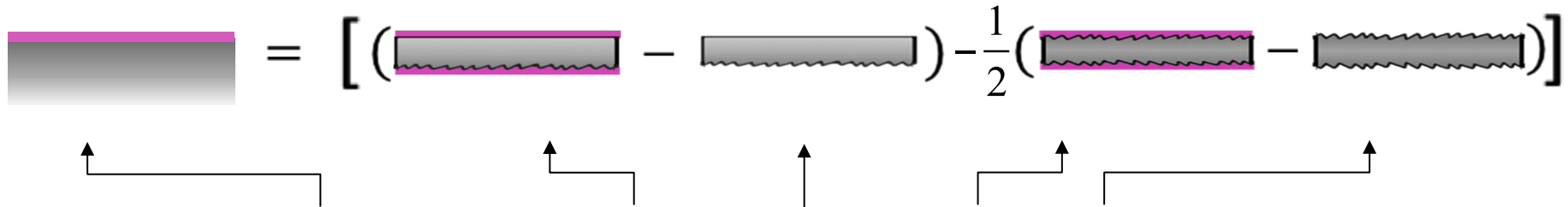


uncoated  
radius of curvature = 1247.0 m

coated on smooth surface  
radius of curvature = 54.8 m

double-side coated  
radius of curvature = 1079.0 m

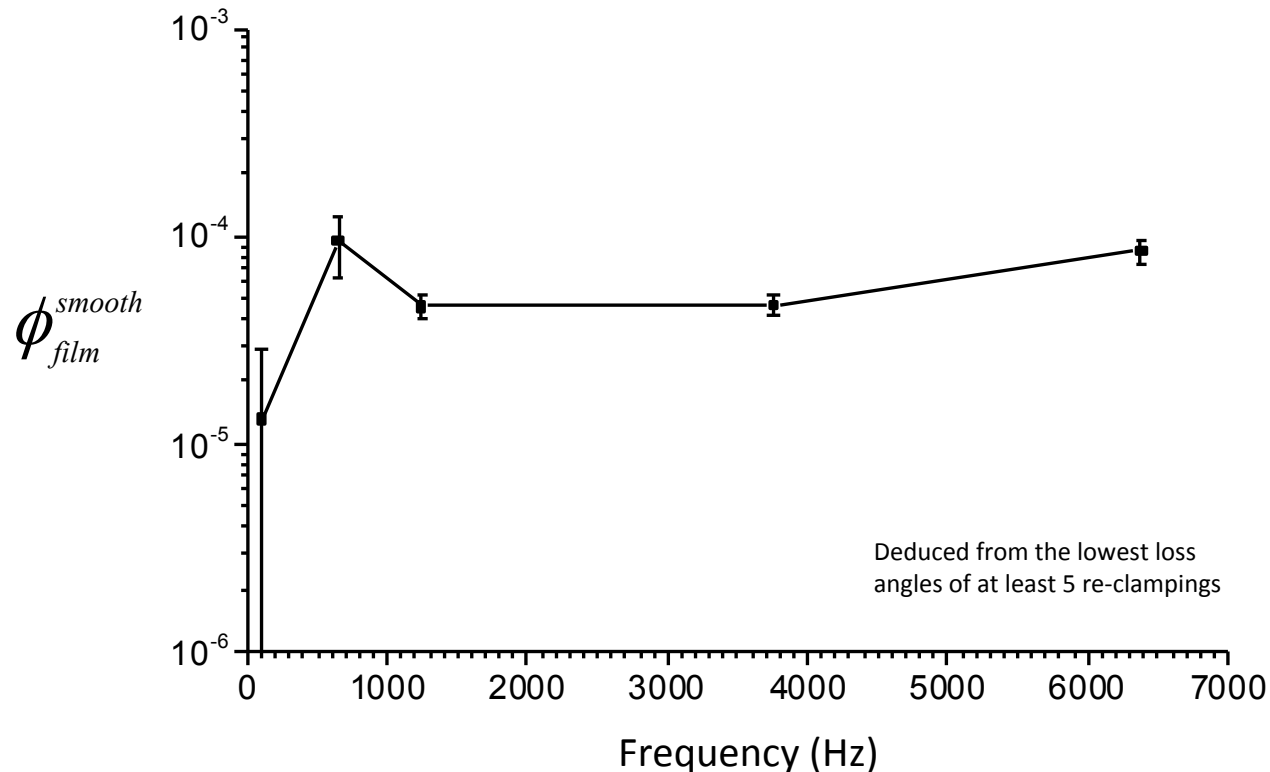
Identical coatings on both sides



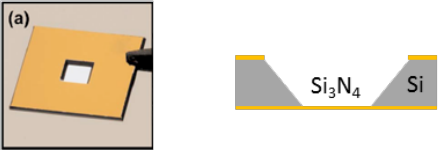
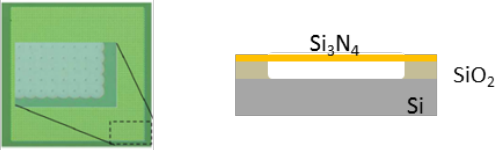
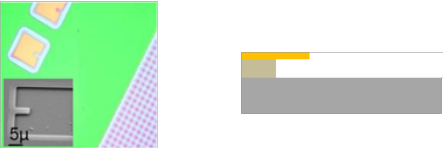


$$\phi_{film}^{smooth} = \frac{Y_s t_s}{3Y_f t_f} \left[ (\phi_{rm} - \phi_{unrm}) - \frac{1}{2} (\phi_{rr} - \phi_{unrr}) \right] \quad \text{[see appendix for derivation]}$$

- $\phi_{film}^{smooth}$  is the loss angle of a film coated on the smooth surface of a substrate that has infinite stiffness or infinite thickness such that there is no warping. **Referred to as the “flat” film.**
- The stress of the “flat” film should be larger than that of the warped film.
- Four types of samples were prepared and the loss angles ( $\phi_{rm}, \phi_{unrm}, \phi_{rr}, \phi_{unrr}$ ) were measured and  $\phi_{film}^{smooth}$  was then deduced.

## Loss angle of the “flat” $\text{SiN}_{0.87}$ film



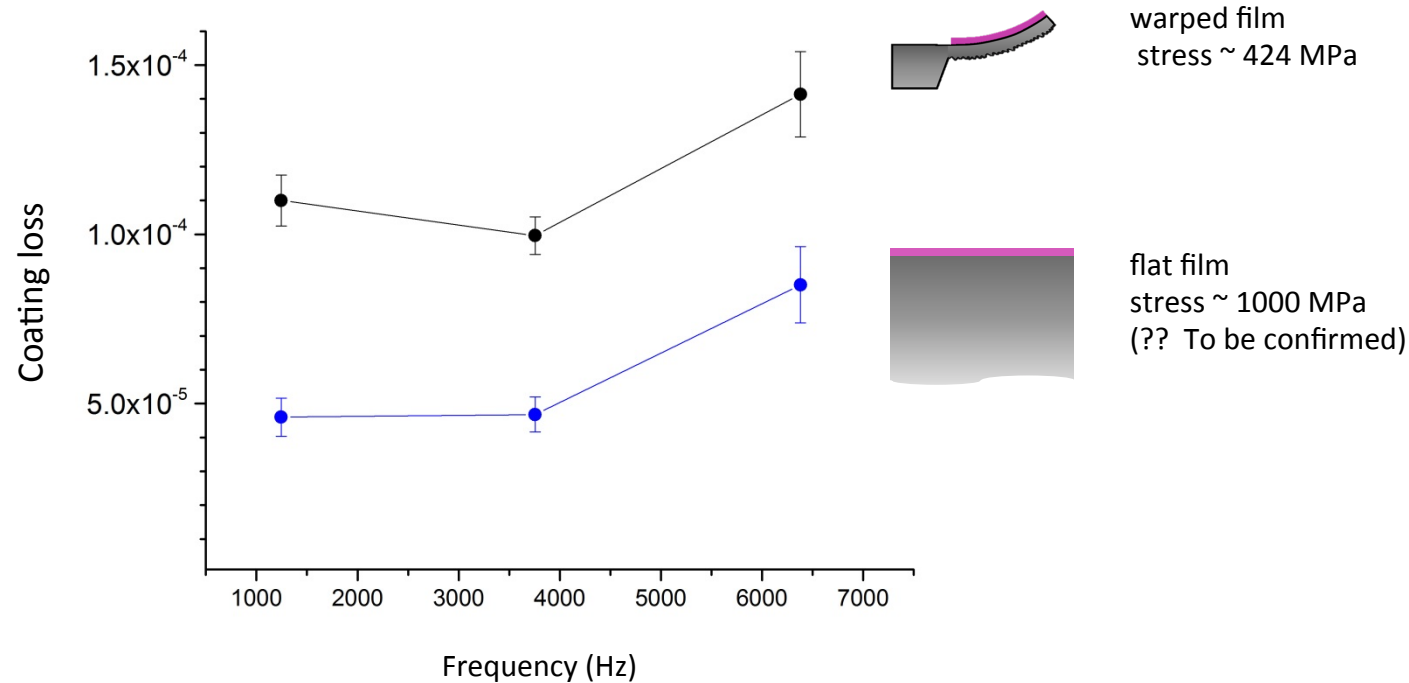
- The un-annealed PECVD  $\text{SiN}_{0.87}$  film has room temperature loss angle in the range of  $10^{-5}$  for frequency  $\sim 100$  Hz to 6500 Hz. It is lower than that of the  $600^\circ\text{C}$  annealed 14.5%  $\text{TiO}_2$ -doped tantala.
- Notice that the “flat” film should be the state of the stressed film on the mirror because the thickness of the mirror substrate can be considered to be infinite.

Geometry & cross-section schema	Stress (MPa)	Loss angle at RT (1/Q)
<p>Si<sub>3</sub>N<sub>4</sub> membrane (1 mm x 1 mm x 50 nm) <sup>[1]</sup></p> 	800	9.09x10 <sup>-7</sup>
<p>Si<sub>3</sub>N<sub>4</sub> membrane (255 μm x 255 μm x 30 nm) <sup>[2]</sup></p> 	1200±50	~2x10 <sup>-6</sup>
<p>Si<sub>3</sub>N<sub>4</sub> stress-relieved cantilever <sup>[2]</sup></p> 	Stress relieved NA	~2x10 <sup>-4</sup>
<p>SiNx doubly-clamped beam <sup>[3]</sup> (15 μm x 200 nm x 120nm)</p> 	1200±50	1x10 <sup>-4</sup>
<p>SiNx singly-clamped cantilever <sup>[3]</sup></p> 	Stress relieved NA	2.5x10 <sup>-4</sup>

These references showed that “flat” film (stress un-relieved) has stress in the vicinity of ~1000 MPa).

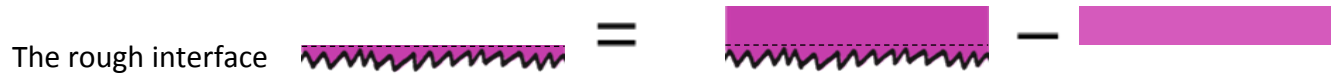
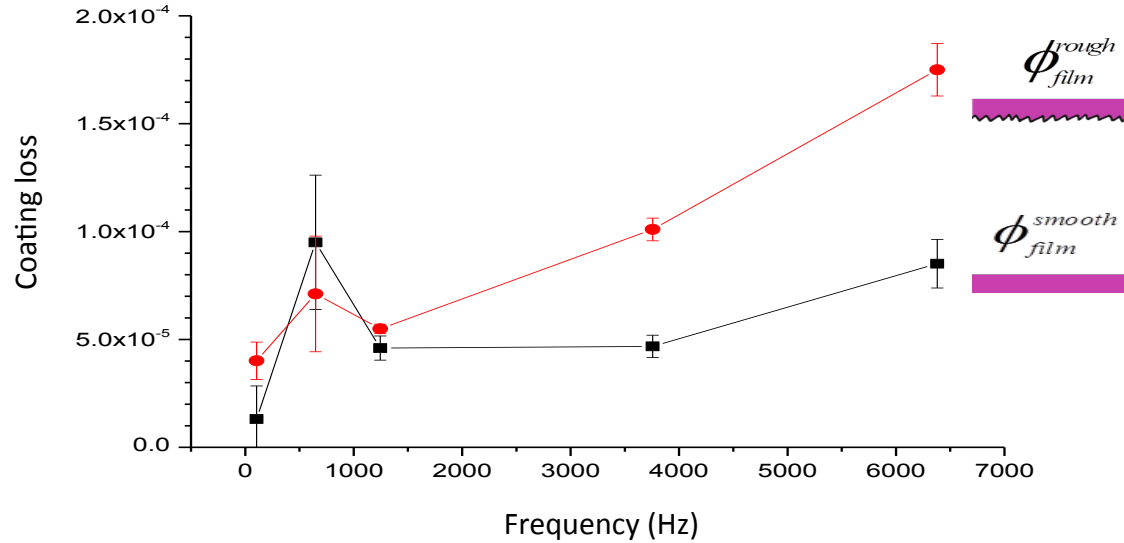
[1]B. M. Zwickl, et al. Appl. Phys. Lett. 92, 2008.[2]D. R. Southworth, et al. PRL 102, 2009.[3]S. S. Verbridge, et al. J. Appl. Phy. 99, 2006.

## Loss angles of the torsion modes



- We have not measured the stress of the “flat” film yet (a film on substrate of very large thickness).
- But, assuming that the stress of the flat film is in the same order of magnitude as the references in the previous slide, i.e. in the vicinity of 1000 MPa, then this result, i.e. the loss angle of the torsion modes for the warped film are larger than that of the flat film, provides direct evidence that the stress indeed reduces the mechanical loss of the SiNx film within the frequency range of laser interference gravitational wave detector.

# A secondary gain Loss angle of the rough interface



$$\phi_{rough\ interface} = \frac{Y_f t_f}{3Y_\delta t_\delta} (\phi_{film}^{rough} - \phi_{film}^{smooth})$$

Young's modulus of silicon = 169 GPa  
 Young's modulus of  $SiN_{0.87}$   $Y_f = 138$  GPa  
 Young's modulus of the rough interface  $Y_\delta$   
 = average of silicon and  $SiN_{0.87} = 153.5$  GPa  
 Thickness of the rough interface  $t_\delta$   
 = roughness 7.7 nm  
 Thickness of the smooth film  $t_f = 218$  nm

Frequency (Hz)	$\phi_{rough\ interface}$
104.2	2.2E-04 ± 1.5E-04
647.6	NA
1245.2 (t)	7.8E-05 ± 5.1E-05
3755.9 (t)	4.7E-04 ± 6.2E-05
6380.3 (t)	8.0E-04 ± 1.4E-04



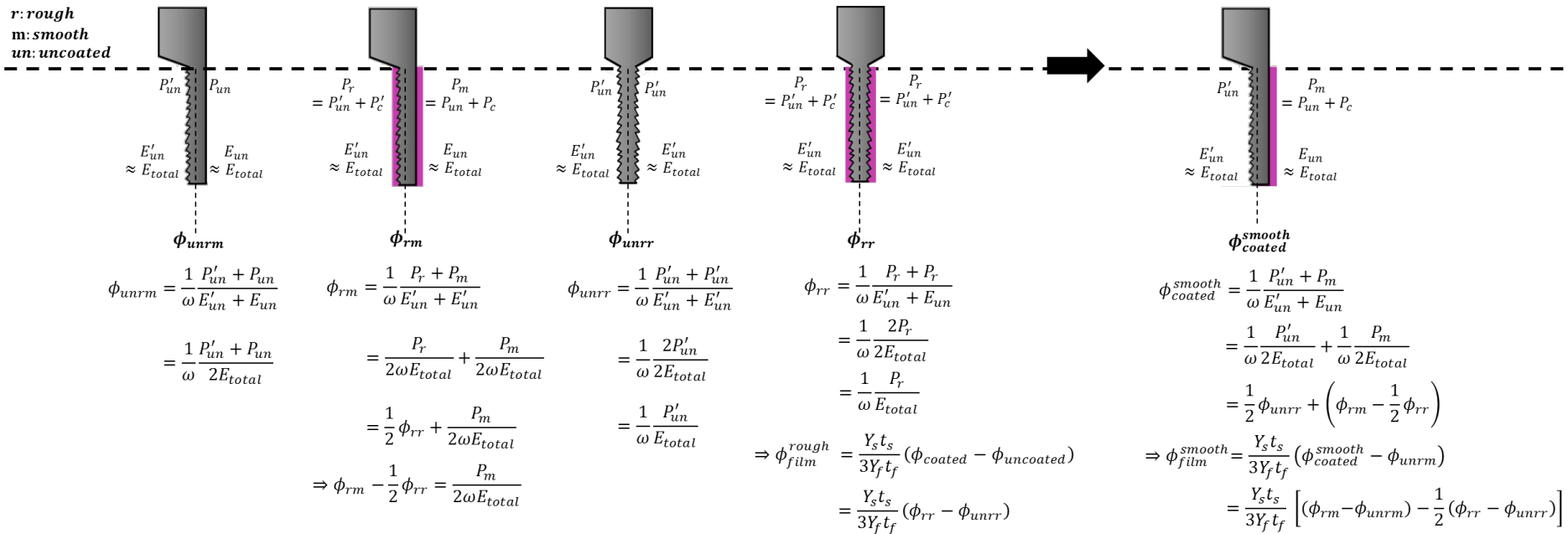
## Conclusion

- We have developed a method to deduce the loss angle of the high stress PECVD  $\text{SiN}_x$  film by using the double-side coatings.
- High stress un-annealed PECVD  $\text{SiN}_{0.87}$  film has room temperature loss angle in the range of  $10^{-5}$  for frequency range from 100 Hz to 6500 Hz . It is lower than that of the 600°C annealed 14.5%  $\text{TiO}_2$ -doped tantala.
- Loss angle of the torsion modes for the warped film and the flat film provided direct evidence that the stress in the  $\text{SiN}_x$  film indeed reduces the mechanical loss.
- A secondary gain of this research is that the loss angle of the rough interface can be obtained by our method. We showed that for a interface with 7.7 nm roughness between the silicon and the  $\text{SiN}_{0.87}$  , the loss angle was in the range from  $8 \times 10^{-5}$  to  $8 \times 10^{-4}$

# Appendix

## Derivation of the loss angle for the “flat” film

P : power loss  
 E : stored energy  
 $\omega$  : angular frequency\*\*  
 $\phi$  : loss angle= $P/\omega E$



$\phi_{film}^{smooth}$  is the loss angle of a film coated on the smooth surface of a substrate that has infinite stiffness or infinite thickness such that there is no warping. **Referred to as the “flat” film.**

\*\* Experimentally, we found that the resonant frequency of the double-side coated samples varied less than 0.1% of the uncoated sample. All samples were considered to have the same frequency.